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CHEMTRONICS

Technical Data Sheet

TDS # CMAQ

Chemask® Aqua

PRODUCT DESCRIPTION

Chemask® Aqua is a high temperature temporary spot mask that protects component-free areas from molten solder during wave soldering. It is water soluble, designed to be removed with open and closed loop aqueous cleaning systems. Chemask® Aqua is low foaming and has no effect on deionized water (DI) system resin beds. This water soluble formulation is stable to rosin, organic and inorganic fluxes.

- Protects boards from molten solder to 515°F (268°C)
- Prolongs deionized water system life
- Low foaming
- Compatible with most flux types
- Leaves no corrosive residue
- Does not contain Methanol
- Non-contaminating

TYPICAL APPLICATIONS

During wave soldering, Chemask® Aqua Solder Masking Agent protects:

- Component Free Areas
- Gold Connectors
- Gold Fingers
- Pin Connectors

TYPICAL PRODUCT DATA AND PHYSICAL PROPERTIES

Base Material	Synthetic Resin
Color	Orange
Flux Compatibility	All types
Temperature Stability	515°F (268°C)
Tack-Free Drying Time (10 mils @ 77°F)	30 min.
Cure Time (10 mils @ 77°F)	1 hour
Viscosity (@ 77°F)	40,000 cps to 50,000 cps
Viscosity Adjusted With	Deionized water
Solids Content	~ 40%
pH	7.0 – 8.0
Weight/Gallon	9.1 lbs.
Shelflife	1 year

COMPATIBILITY

Chemask® Aqua Solder Masking Agent is generally compatible with most materials used in printed circuit board fabrication. As with any solder masking agent, compatibility with substrate must be determined on a non-critical area prior to use.

APPLICATION METHOD

Squeeze Bottle/Syringe	Yes
Spatula	Yes
Screening	Yes
Stencil	Yes
Automatic Dispensing	Yes

USAGE INSTRUCTIONS

For industrial use only.

When applying by hand using squeeze bottle, syringe or spatula, insure that all areas of the pre-tinned hole are evenly covered on the side to be soldered. For screening applications, properly clean and prepare screen, then apply masking agent in the same manner as solder paste. Automatic dispensing equipment may also be used as appropriate. Allow an hour to fully cure a 10 mil thick application. Thicker applications will require additional cure time. Rapid cure can be achieved in a 120°F oven.

REMOVAL: After allowing the mask to become fully cured, the mask may be washed away in an open or closed loop aqueous cleaning system with water temperature at a minimum 120°F under agitation. If using a recirculating system, install a minimum 10 micron bag filter before the resin beds.

Detergents may be used to increase cleaning efficiency.

AVAILABILITY

CMAQ8 8 oz. Liquid Squeeze Bottle
 CMAQ1 1 Gal. Liquid

TECHNICAL & APPLICATION ASSISTANCE

Chemtronics provides a technical hotline to answer your technical and application related questions. The toll free number is: **1-800-TECH-401.**

ENVIRONMENTAL IMPACT DATA

ENVIRONMENTAL IMPACT DATA			
CFC	0.0%	VOC	5.0%
HCFC	0.0%	HFC	0.0%
Cl. Solv.	0.0%	ODP	0.0%

CFC, HCFC, CL. SOLV., VOC, and HFC numbers shown are the content by weight. Ozone depletion potential (ODP) is determined in accordance with the Montreal Protocol and U.S. Clean Air Act of 1990. The ODP of this product is zero.

NOTE:

This information is believed to be accurate. It is intended for professional end users having the skills to evaluate and use the data properly. CHEMTRONICS does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.

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